



UNISONIC TECHNOLOGIES CO., LTD

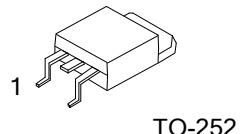
6NL50

Power MOSFET

6A, 500V N-CHANNEL SUPER-JUNCTION MOSFET

■ DESCRIPTION

The **UTC 6NL50** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

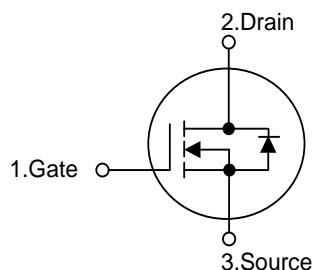


TO-252

■ FEATURES

- * $R_{DS(ON)} \leq 1.5 \Omega$ @ $V_{GS}=10V$, $I_D=3.0A$
- * Fast switching
- * 100% avalanche tested
- * Improved dv/dt capability

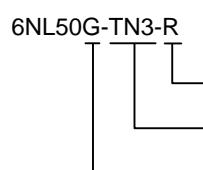
■ SYMBOL



■ ORDERING INFORMATION

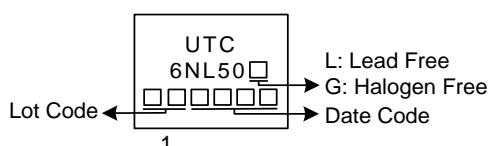
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
6NL50L-TN3-R	6NL50G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source



- (1) R: Tape Reel
- (2) TN3: TO-252
- (3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_c = 25^\circ\text{C}$ unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V_{DSS}	500	V
Gate-Source Voltage	V_{GSS}	± 30	V
Drain Current	Continuous I_D	6	A
	Pulsed (Note 2) I_{DM}	12	A
Avalanche Energy	Single Pulsed (Note 3) E_{AS}	126	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	4.8	V/ns
Power Dissipation	P_D	50	W
Junction Temperature	T_J	+150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature

3. $L = 30\text{mH}$, $I_{AS} = 2.9\text{A}$, $V_{DD} = 100\text{V}$, $R_G = 25 \Omega$ Starting $T_J = 25^\circ\text{C}$

4. $I_{SD} \leq 6.0\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	110	$^\circ\text{C/W}$
Junction to Case	θ_{JC}	2.5 (Note)	$^\circ\text{C/W}$

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

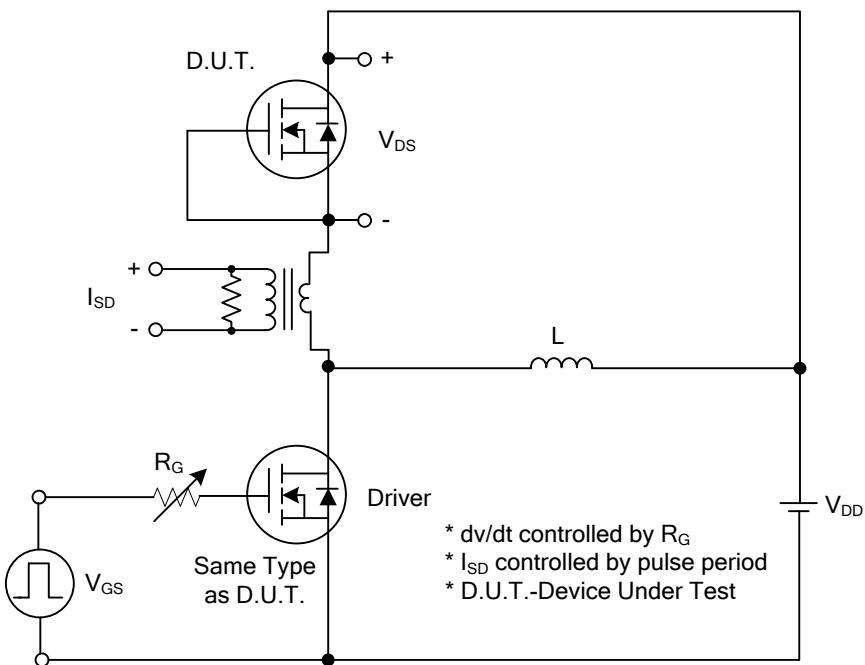
■ ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	500			V
Drain-Source Leakage Current	I_{DSS}	$\text{V}_{\text{DS}}=500\text{V}, \text{V}_{\text{GS}}=0\text{V}$		10		μA
Gate-Source Leakage Current	Forward	$\text{V}_{\text{GS}}=30\text{V}, \text{V}_{\text{DS}}=0\text{V}$		100	nA	
	Reverse	$\text{V}_{\text{GS}}=-30\text{V}, \text{V}_{\text{DS}}=0\text{V}$		-100	nA	
ON CHARACTERISTICS						
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{TH})}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=3.0\text{A}$			1.5	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{ISS}	$\text{V}_{\text{DS}}=25\text{V}, \text{V}_{\text{GS}}=0\text{V}, f=1.0 \text{ MHz}$		368		pF
Output Capacitance	C_{OSS}			172		pF
Reverse Transfer Capacitance	C_{RSS}			19		pF
SWITCHING CHARACTERISTICS						
Total Gate Charge	Q_G	$\text{V}_{\text{DS}}=400\text{V}, \text{V}_{\text{GS}}=10\text{V}, \text{I}_D=6\text{A}$ $\text{I}_G=1\text{mA}$ (Note1, 2)		13.8		nC
Gate-Source Charge	Q_{GS}			3.2		nC
Gate-Drain Charge	Q_{GD}			4		nC
Turn-On Delay Time	$t_{\text{D}(\text{ON})}$	$\text{V}_{\text{DS}}=100\text{V}, \text{V}_{\text{GS}}=10\text{V}, \text{I}_D=6\text{A},$ $\text{R}_G=25\Omega$ (Note1, 2)		5.2		ns
Turn-On Rise Time	t_R			17		ns
Turn-Off Delay Time	$t_{\text{D}(\text{OFF})}$			40		ns
Turn-Off Fall Time	t_F			24		ns
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Maximum Continuous Drain-Source Diode Forward Current	I_S				6	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				12	A
Drain-Source Diode Forward Voltage	V_{SD}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_S=6\text{A}$			1.4	V
Reverse Recovery Time	t_{rr}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_S=6\text{A},$ $d\text{I}_F/dt=100\text{A}/\mu\text{s}$ (Note1)		240		ns
Reverse Recovery Charge	Q_{rr}			4.3		μC

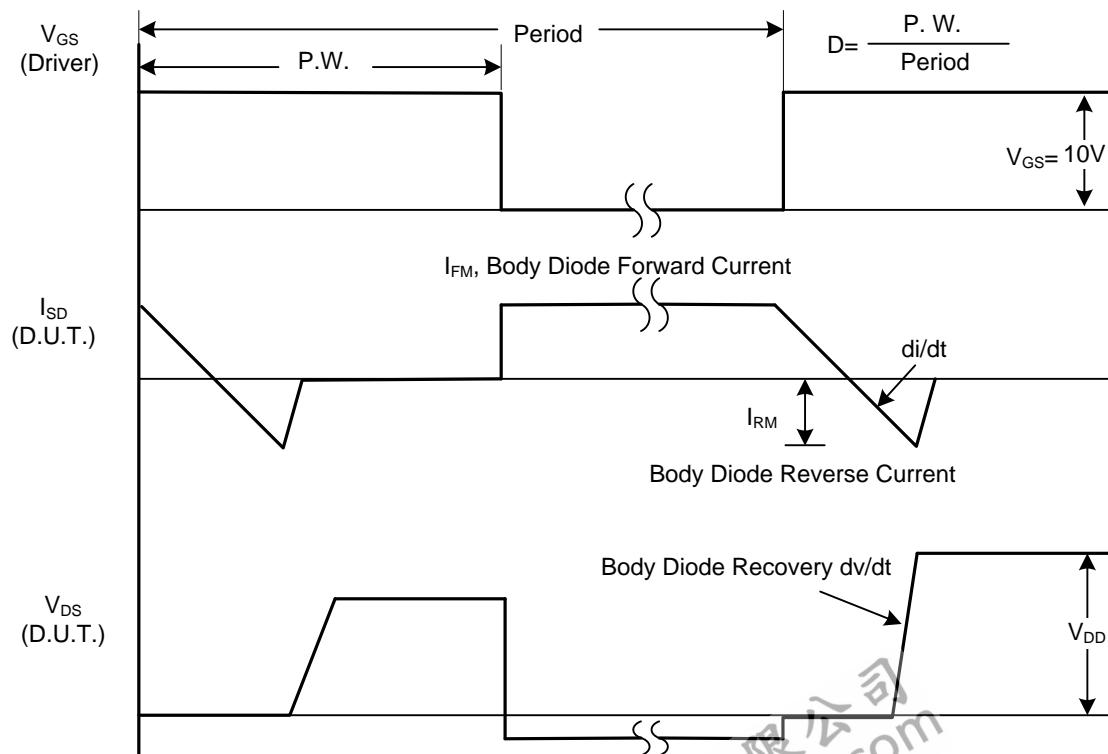
Notes: 1. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

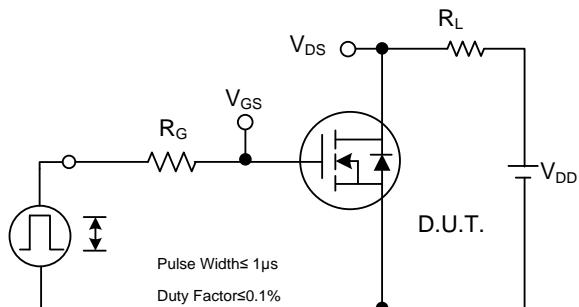


Peak Diode Recovery dv/dt Test Circuit

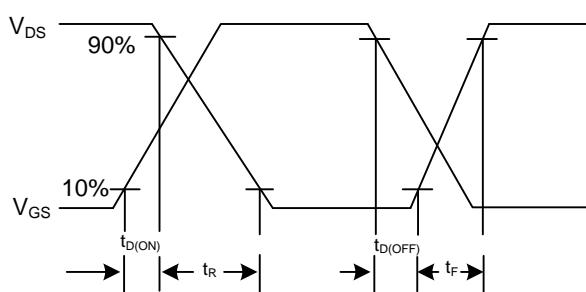


Peak Diode Recovery dv/dt Waveforms

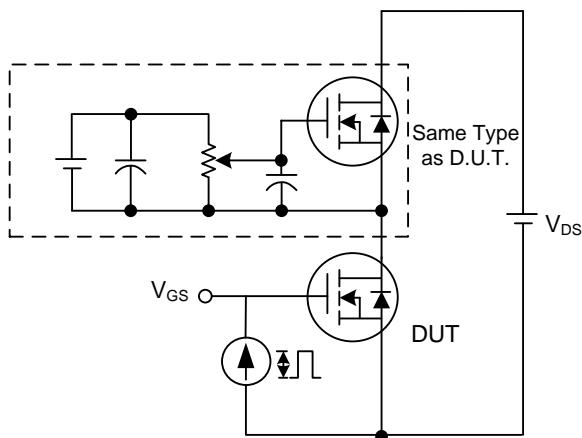
■ TEST CIRCUITS AND WAVEFORMS



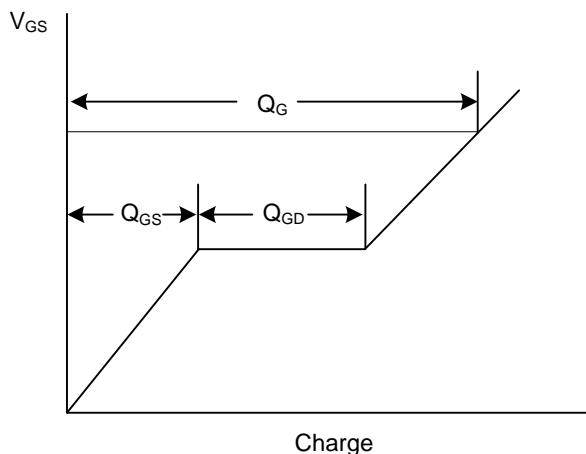
Switching Test Circuit



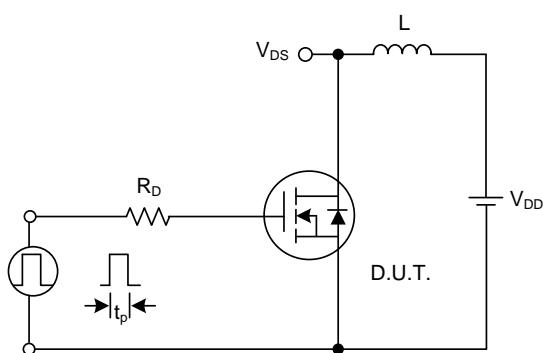
Switching Waveforms



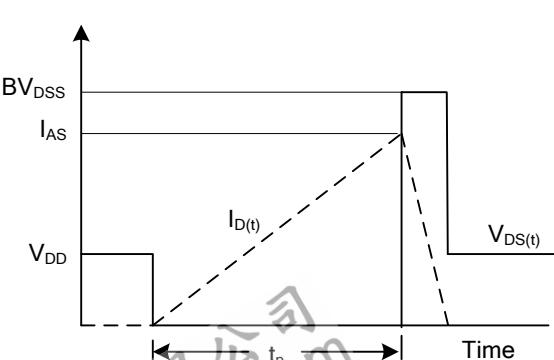
Gate Charge Test Circuit



Gate Charge Waveform

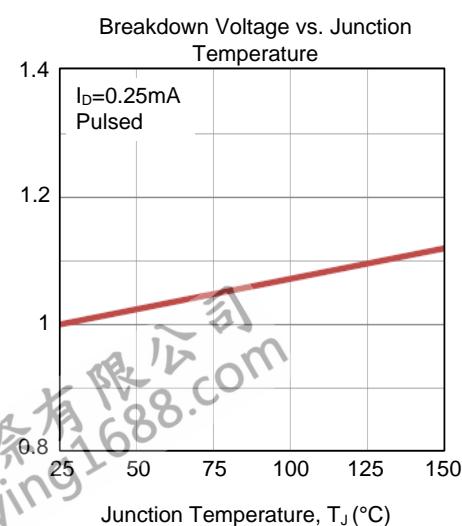
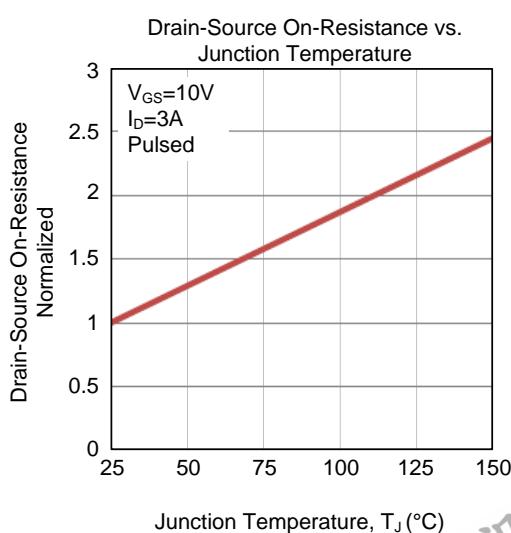
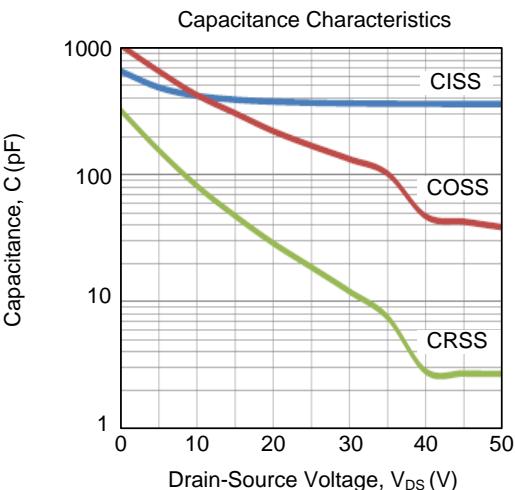
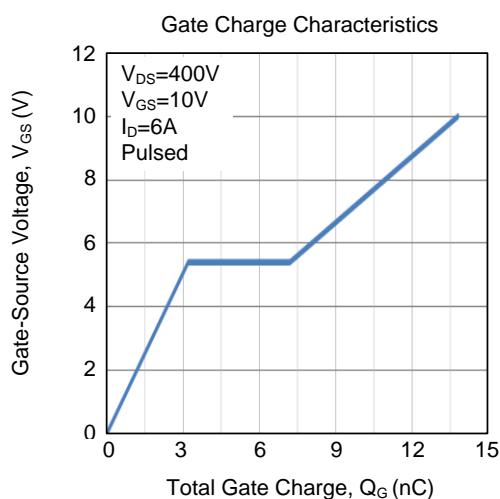
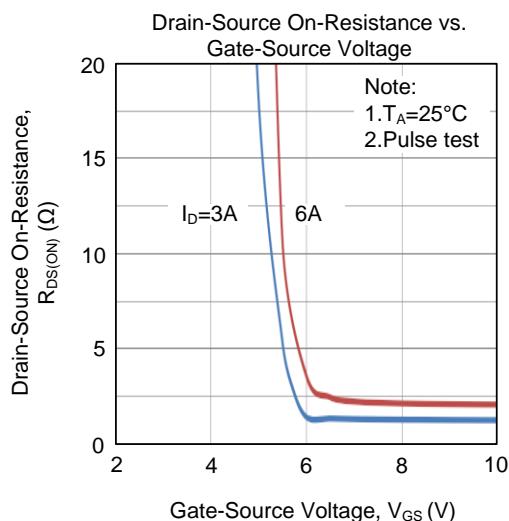
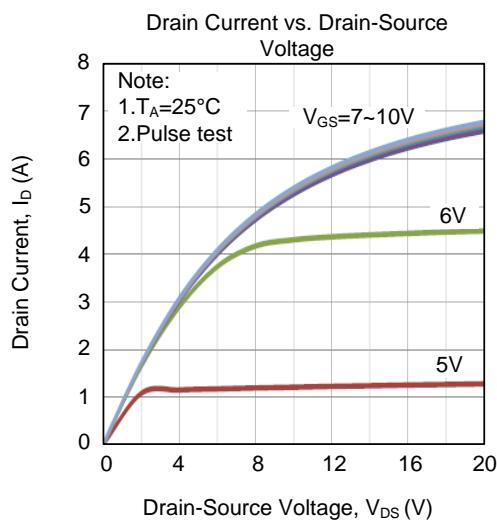


Unclamped Inductive Switching Test Circuit

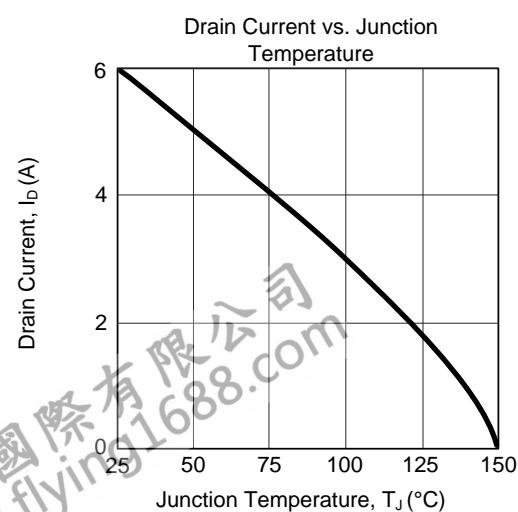
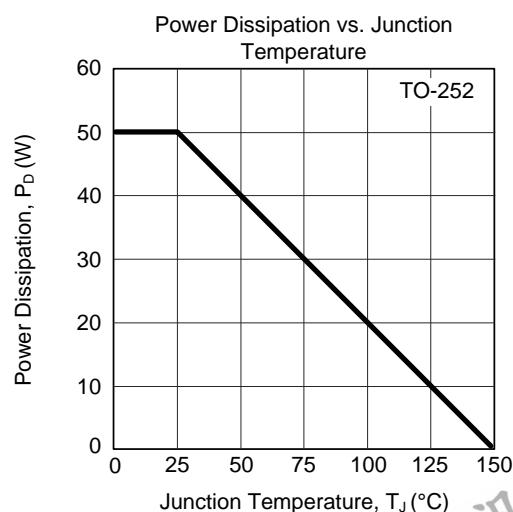
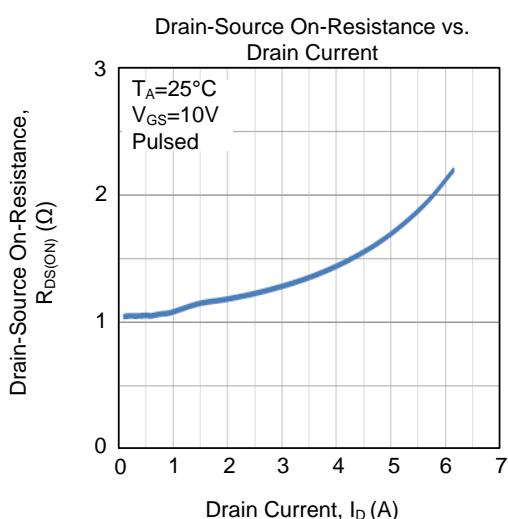
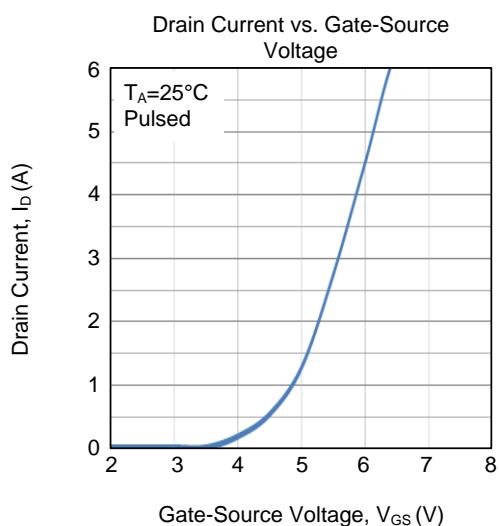
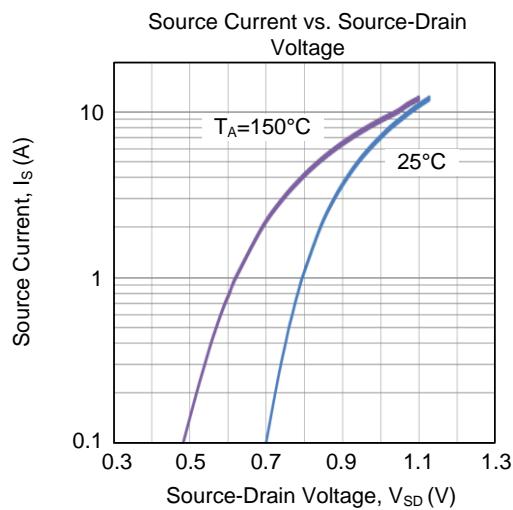
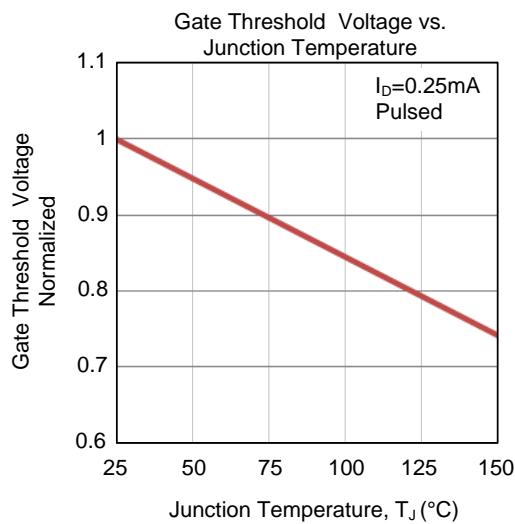


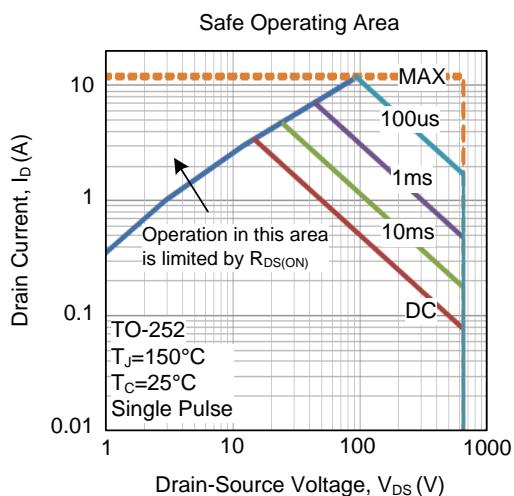
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)

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